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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details	
Product Status	Obsolete
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I²C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	925MHz
Primary Attributes	FPGA - 350K Logic Elements
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FBGA, FC (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5asxmb3g4f40c4n

Advantage	Supporting Feature
Lowest system cost	• Requires as few as four power supplies to operate • Available in thermal composite flip chip ball-grid array (BGA) packaging • Includes innovative features such as Configuration via Protocol (CvP), partial reconfiguration, and design security

Summary of Arria V Features

Table 2: Summary of Features for Arria V Devices

Feature	Description

Technology	• TSMC's 28-nm process technology:
	  • Arria V GX, GT, SX, and ST—28-nm low power (28LP) process
	  • Arria V GZ—28-nm high performance (28HP) process
	• Lowest static power in its class (less than 1.2 W for 500K logic elements (LEs) at 85°C junction under typical conditions)
	• 0.85 V, 1.1 V, or 1.15 V core nominal voltage

Packaging	• Thermal composite flip chip BGA packaging • Multiple device densities with identical package footprints for seamless migration between different device densities • Leaded(1), lead-free (Pb-free), and RoHS-compliant options
High-performance FPGA fabric	• Enhanced 8-input ALM with four registers • Improved routing architecture to reduce congestion and improve compilation time
Internal memory blocks	• M10K—10-kilobits (Kb) memory blocks with soft error correction code (ECC) (Arria V GX, GT, SX, and ST devices only) • M20K—20-Kb memory blocks with hard ECC (Arria V GZ devices only) • Memory logic array block (MLAB)-640-bit distributed LUTRAM where you can use up to 50% of the ALMs as MLAB memory

(1) Contact Altera for availability.

Feature	Description	

Embedded Hard IP blocks	Variable-precision DSP	• Native support for up to four signal processing precision levels:
		  • Three 9 x 9, two 18 x 18, or one 27 x 27 multiplier in the same variable-precision DSP block
		  • One 36 x 36 multiplier using two variable-precision DSP blocks (Arria V GZ devices only)
		• 64-bit accumulator and cascade for systolic finite impulse responses (FIRs)
		• Embedded internal coefficient memory
		• Preadder/subtractor for improved efficiency

	Memory controller (Arria V GX, GT, SX, and ST only)	DDR3 and DDR2

	Embedded transceiver I/O	• Custom implementation:
		  • Arria V GX and SX devices—up to 6.5536 Gbps
		  • Arria V GT and ST devices—up to 10.3125 Gbps
		  • Arria V GZ devices—up to 12.5 Gbps
		• PCI Express® (PCIe®) Gen2 (x1, x2, or x4) and Gen1 (x1, x2, x4, or x8) hard IP with multifunction support, endpoint, and root port
		• PCIe Gen3 (x1, x2, x4, or x8) support (Arria V GZ only)
		• Gbps Ethernet (GbE) and XAUI physical coding sublayer (PCS)
		• Common Public Radio Interface (CPRI) PCS
		• Gigabit-capable passive optical network (GPON) PCS
		• 10-Gbps Ethernet (10GbE) PCS (Arria V GZ only)
		• Serial RapidIO® (SRIO) PCS
		• Interlaken PCS (Arria V GZ only)

Clock networks	• Up to 650 MHz global clock network • Global, quadrant, and peripheral clock networks • Clock networks that are not used can be powered down to reduce dynamic power	
Phase-locked loops (PLLs)	• High-resolution fractional PLLs • Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) • Integer mode and fractional mode • LC oscillator ATX transmitter PLLs (Arria V GZ only)	

Feature	Description
FPGA General-purpose I/Os (GPIOs)	• 1.6 Gbps LVDS receiver and transmitter • 800 MHz/1.6 Gbps external memory interface • On-chip termination (OCT) • 3.3 V support (2)
External Memory Interface	Memory interfaces with low latency: • Hard memory controller-up to 1.066 Gbps • Soft memory controller-up to 1.6 Gbps
Low-power high-speed serial interface	• 600 Mbps to 12.5 Gbps integrated transceiver speed • Less than 105 mW per channel at 6 Gbps, less than 165 mW per channel at 10 Gbps, and less than 170 mW per channel at 12.5 Gbps • Transmit pre-emphasis and receiver equalization • Dynamic partial reconfiguration of individual channels • Physical medium attachment (PMA) with soft PCS that supports 9.8304 Gbps CPRI (Arria V GT and ST only) • PMA with hard PCS that supports up to 9.8 Gbps CPRI (Arria V GZ only) • Hard PCS that supports 10GBASE-R and 10GBASE-KR (Arria V GZ only)
HPS (Arria V SX and ST devices only)	• Dual-core ARM Cortex-A9 MPCore processor—up to 1.05 GHz maximum frequency with support for symmetric and asymmetric multiprocessing • Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, serial peripheral interface (SPI), I2C interface, and up to 85 HPS GPIO interfaces • System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers • On-chip RAM and boot ROM • HPS–FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa • FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller • ARM CoreSight™ JTAG debug access port, trace port, and on-chip trace storage

(2) Arria V GZ devices support 3.3 V with a 3.0 V V_{CCIO}.

Feature	Description
Configuration	• Tamper protection-comprehensive design protection to protect your valuable IP investments • Enhanced advanced encryption standard (AES) design security features • CvP • Partial and dynamic reconfiguration of the FPGA • Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8, x16, and x32 (Arria V GZ) configuration options • Remote system upgrade

Arria V Device Variants and Packages

Table 3: Device Variants for the Arria V Device Family

Variant	Description
Arria V GX	FPGA with integrated 6.5536 Gbps transceivers that provides bandwidth, cost, and power levels that are optimized for high-volume data and signal-processing applications
Arria V GT	FPGA with integrated 10.3125 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for cost-sensitive data and signal processing applications
Arria V GZ	FPGA with integrated 12.5 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for high-performance and cost-sensitive data and signal processing applications
Arria V SX	SoC with integrated ARM-based HPS and 6.5536 Gbps transceivers
Arria V ST	SoC with integrated ARM-based HPS and 10.3125 Gbps transceivers

Arria V GX

This section provides the available options, maximum resource counts, and package plan for the Arria V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Resource		Member Code							
		A1	A3	A5	A7	B1	B3	B5	B7
6 Gbps Transceiver		9	9	24	24	24	24	36	36
GPIO(3)		416	416	544	544	704	704	704	704
LVDS	Transmitter	67	67	120	120	160	160	160	160
	Receiver	80	80	136	136	176	176	176	176
PCIe Hard IP Block		1	1	2	2	2	2	2	2
Hard Memory Controller		2	2	4	4	4	4	4	4

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook
Provides the number of LVDS channels in each device package.

Package Plan

Table 5: Package Plan for Arria V GX Devices

Member Code	F672 (27 mm)		F896 (31 mm)		F1152 (35 mm)		F1517 (40 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
A1	336	9	416	9	—	—	—	—
A3	336	9	416	9	—	—	—	—
A5	336	9	384	18	544	24	—	—
A7	336	9	384	18	544	24	—	—
B1	—	—	384	18	544	24	704	24
B3	—	—	384	18	544	24	704	24
B5	—	—	—	—	544	24	704	36
B7	—	—	—	—	544	24	704	36

Arria V GT

This section provides the available options, maximum resource counts, and package plan for the Arria V GT devices.

(3) The number of GPIOs does not include transceiver I/Os. In the Quartus® Prime software, the number of user I/Os includes transceiver I/Os.

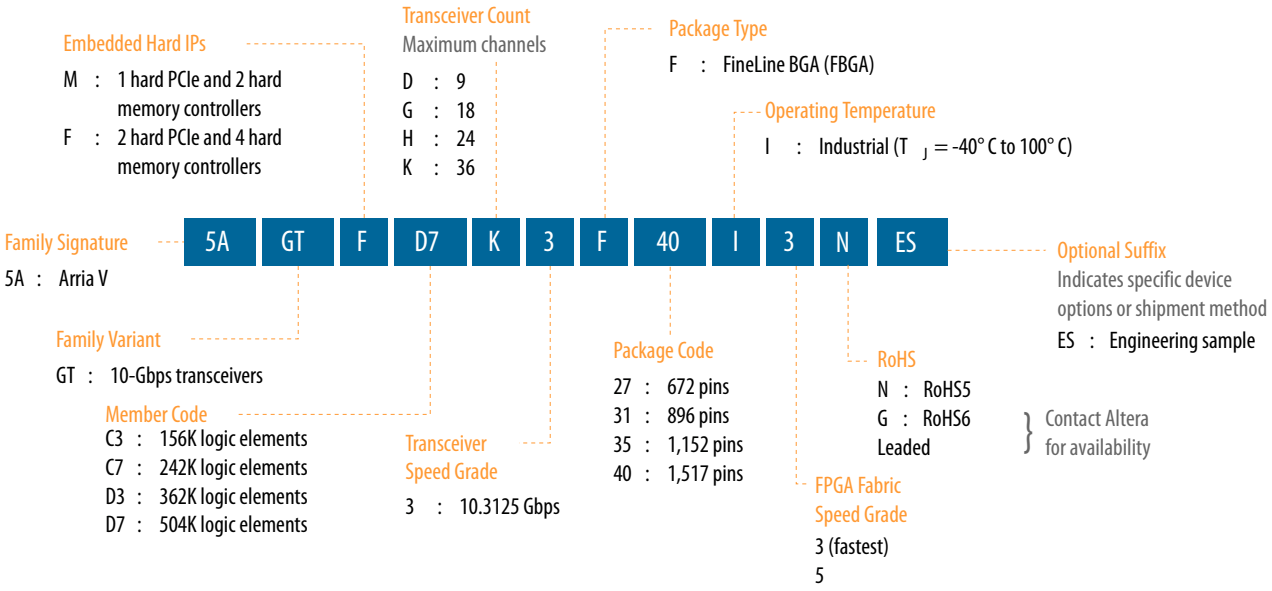
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 2: Sample Ordering Code and Available Options for Arria V GT Devices



Maximum Resources

Table 6: Maximum Resource Counts for Arria V GT Devices

Resource		Member Code			
		C3	C7	D3	D7
Logic Elements (LE) (K)		156	242	362	504
ALM		58,900	91,680	136,880	190,240
Register		235,600	366,720	547,520	760,960
Memory (Kb)	M10K	10,510	13,660	17,260	24,140
	MLAB	961	1,448	2,098	2,906
Variable-precision DSP Block		396	800	1,045	1,156
18 x 18 Multiplier		792	1,600	2,090	2,312
PLL		10	12	12	16

and eighteen 10-Gbps, twelve 6-Gbps and sixteen 10-Gbps, fifteen 6-Gbps and fourteen 10-Gbps, or up to thirty-six 6-Gbps with no 10-Gbps channels.

Arria V GZ

This section provides the available options, maximum resource counts, and package plan for the Arria V GZ devices.

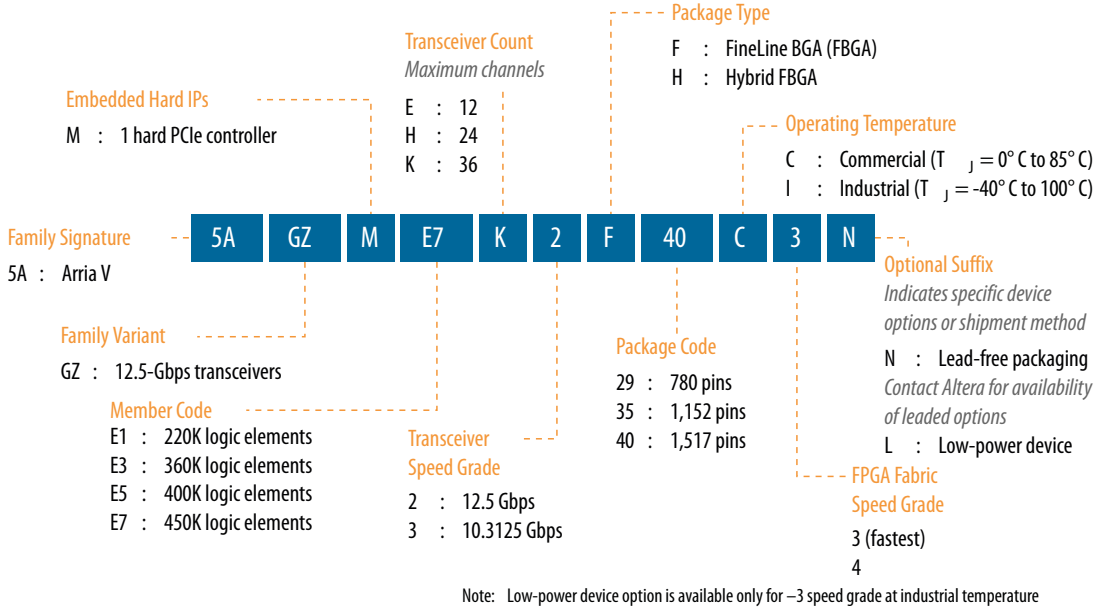
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 3: Sample Ordering Code and Available Options for Arria V GZ Devices



Note: Low-power device option is available only for –3 speed grade at industrial temperature

Maximum Resources

Table 8: Maximum Resource Counts for Arria V GZ Devices

Resource	Member Code			
	E1	E3	E5	E7
Logic Elements (LE) (K)	220	360	400	450
ALM	83,020	135,840	150,960	169,800
Register	332,080	543,360	603,840	679,200

Resource		Member Code			
		E1	E3	E5	E7
Memory (Kb)	M20K	11,700	19,140	28,800	34,000
	MLAB	2,594	4,245	4,718	5,306
Variable-precision DSP Block		800	1,044	1,092	1,139
18 x 18 Multiplier		1,600	2,088	2,184	2,278
PLL		20	20	24	24
12.5 Gbps Transceiver		24	24	36	36
GPIO[7]		414	414	674	674
LVDS	Transmitter	99	99	166	166
	Receiver	108	108	168	168
PCIe Hard IP Block		1	1	1	1

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook
Provides the number of LVDS channels in each device package.

Package Plan

Table 9: Package Plan for Arria V GZ Devices

Member Code	H780 (33 mm)		F1152 (35 mm)		F1517 (40 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
E1	342	12	414	24	—	—
E3	342	12	414	24	—	—
E5	—	—	534	24	674	36
E7	—	—	534	24	674	36

Arria V SX

This section provides the available options, maximum resource counts, and package plan for the Arria V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

(7) The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

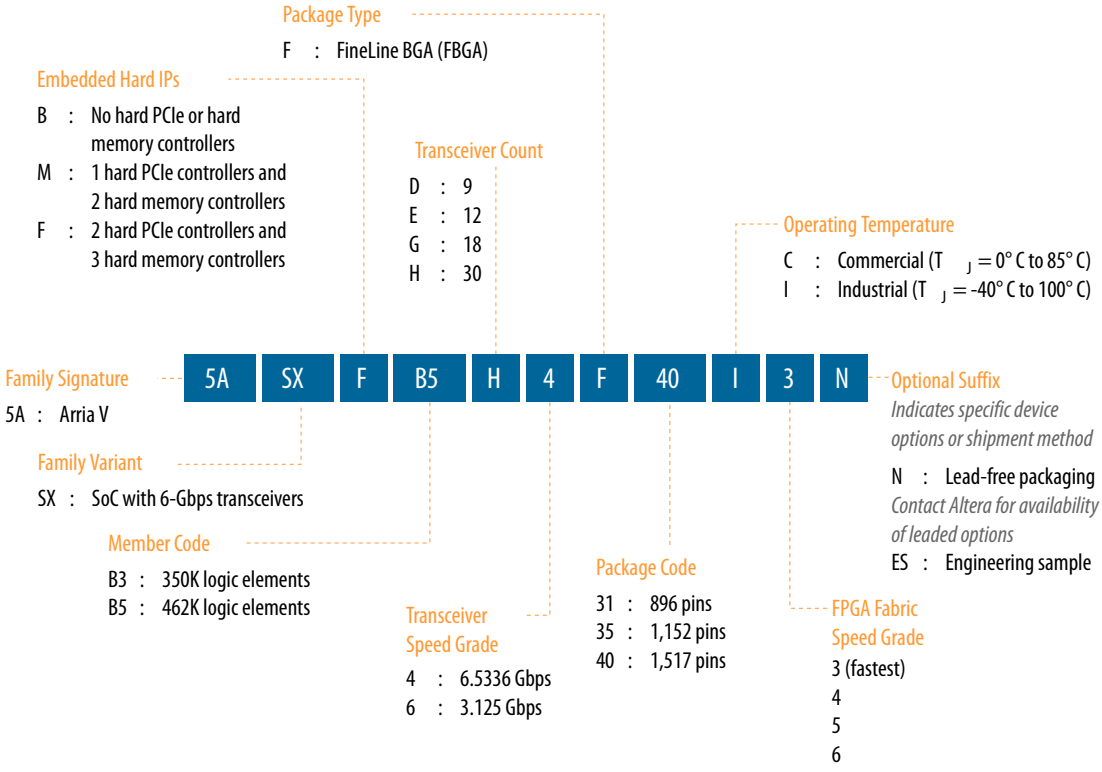
Related Information

Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 4: Sample Ordering Code and Available Options for Arria V SX Devices

The –3 FPGA fabric speed grade is available only for industrial temperature devices.



Maximum Resources

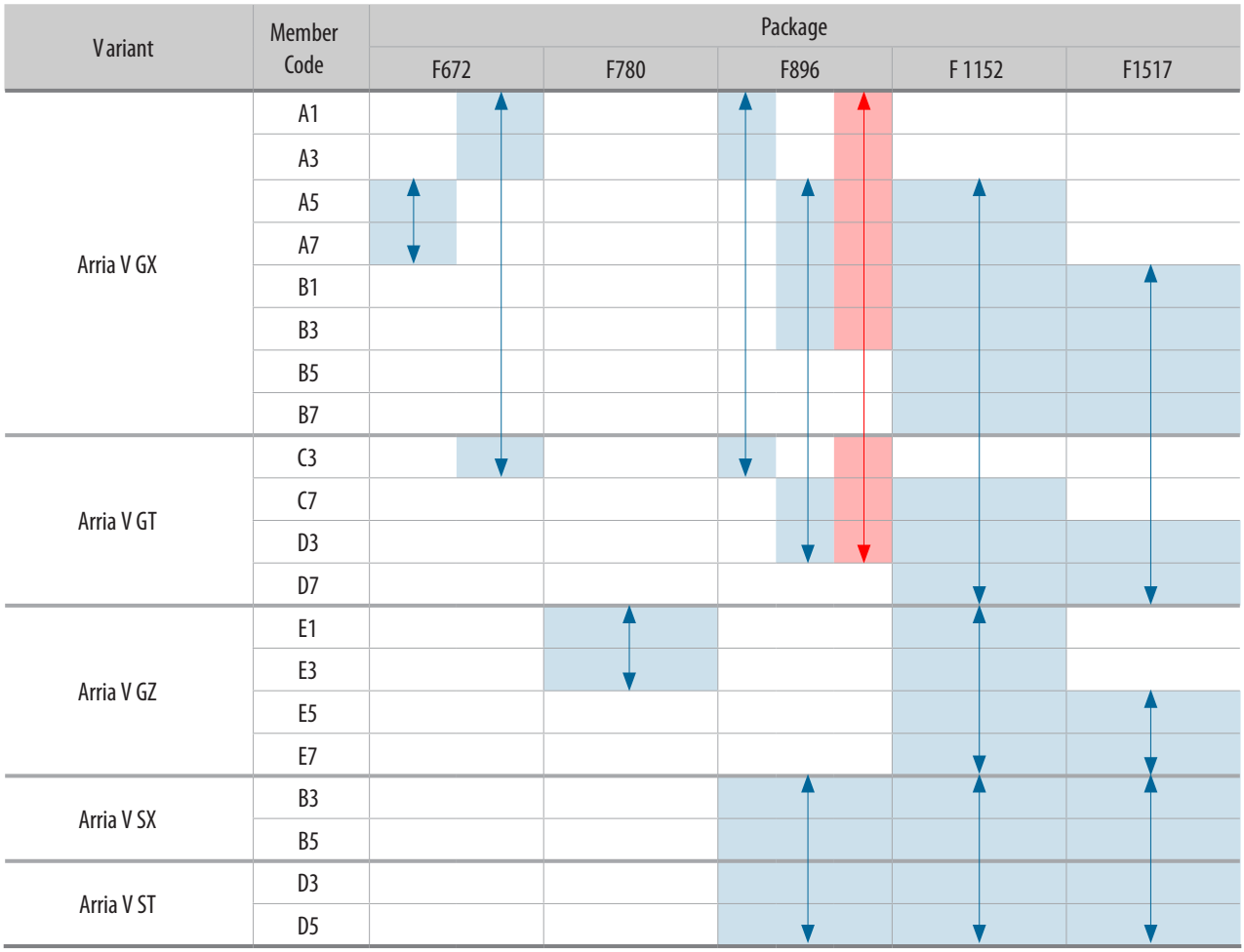
Table 10: Maximum Resource Counts for Arria V SX Devices

Resource		Member Code	
		B3	B5
Logic Elements (LE) (K)		350	462
ALM		132,075	174,340
Register		528,300	697,360
Memory (Kb)	M10K	17,290	22,820
	MLAB	2,014	2,658
Variable-precision DSP Block		809	1,090
18 x 18 Multiplier		1,618	2,180

I/O Vertical Migration for Arria V Devices

Figure 6: Vertical Migration Capability Across Arria V Device Packages and Densities

The arrows indicate the vertical migration paths. Some packages have several migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 320 GPIOs, up to nine 6 Gbps transceiver channels, and up to four 10 Gbps transceiver (for Arria V GT devices). This migration path is not shown in the Quartus Prime software Pin Migration View.

Note: To verify the pin migration compatibility, use the Pin Migration View window in the Quartus Prime software Pin Planner.

Note: Except for Arria V GX A5 and A7, and Arria V GT C7 devices, all other Arria V GX and GT devices require a specific power-up sequence. If you plan to migrate your design from Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices, your design must adhere to the same required power-up sequence.

Variable-Precision DSP Block

Arria V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18, 27 x 27, and 36 x 36 bits natively
- A 64-bit accumulator
- Double accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Dynamic coefficients
- 18-bit internal coefficient register banks
- Enhanced independent multiplier operation
- Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Quartus Prime design software

Table 14: Variable-Precision DSP Block Configurations for Arria V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters	Two 18 x 18 with accumulate	1
Single-precision floating-point implementations	One 27 x 27	1
Very high precision fixed point implementations	One 36 x 36	2

You can configure each DSP block during compilation as independent three 9 x 9, two 18 x 18, or one 27 x 27 multipliers. Using two DSP block resources, you can also configure a 36 x 36 multiplier for high-precision applications. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

Types of Embedded Memory

The Arria V devices contain two types of memory blocks:

- 20 Kb M20K or 10 Kb M10K blocks—blocks of dedicated memory resources. The M20K and M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Arria V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB. You can also configure these ALMs, in Arria V GZ devices, as ten 64 x 1 blocks, giving you one 64 x 10 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Arria V Devices

Table 16: Embedded Memory Capacity and Distribution in Arria V Devices

Variant	Member Code	M20K		M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Arria V GX	A1	—	—	800	8,000	741	463	8,463
	A3	—	—	1,051	10,510	1538	961	11,471
	A5	—	—	1,180	11,800	1877	1,173	12,973
	A7	—	—	1,366	13,660	2317	1,448	15,108
	B1	—	—	1,510	15,100	2964	1,852	16,952
	B3	—	—	1,726	17,260	3357	2,098	19,358
	B5	—	—	2,054	20,540	4052	2,532	23,072
	B7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GT	C3	—	—	1,051	10,510	1538	961	11,471
	C7	—	—	1,366	13,660	2317	1,448	15,108
	D3	—	—	1,726	17,260	3357	2,098	19,358
	D7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GZ	E1	585	11,700	—	—	4,151	2,594	14,294
	E3	957	19,140	—	—	6,792	4,245	23,385
	E5	1,440	28,800	—	—	7,548	4,718	33,518
	E7	1,700	34,000	—	—	8,490	5,306	39,306
Arria V SX	B3	—	—	1,729	17,290	3223	2,014	19,304
	B5	—	—	2,282	22,820	4253	2,658	25,478

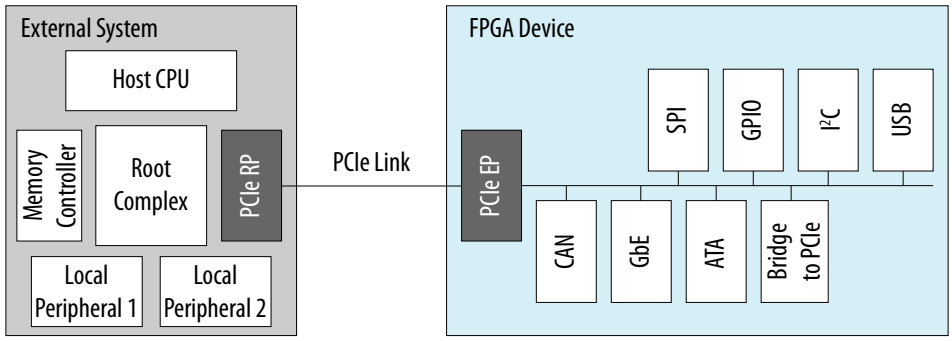
PCIe Gen1, Gen2, and Gen 3 Hard IP

Arria V devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen3, Gen 2, and Gen 1 end point and root port for up to x8 lane configuration.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

Figure 8: PCIe Multifunction for Arria V Devices



The Arria V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Arria V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Arria V device provides improved end-to-end datapath protection using ECC.

External Memory Interface

This section provides an overview of the external memory interface in Arria V devices.

Hard and Soft Memory Controllers

Arria V GX,GT, SX, and ST devices support up to four hard memory controllers for DDR3 and DDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Arria V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Arria V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices, QDR II+, QDR II, and DDR II+ SRAM devices, and RLDRAM II devices for maximum flexibility.

Note: DDR3 SDRAM leveling is supported only in Arria V GZ devices.

External Memory Performance

Table 18: External Memory Interface Performance in Arria V Devices

Interface	Voltage (V)	Hard Controller (MHz)	Soft Controller (MHz)	
		Arria V GX, GT, SX, and ST	Arria V GX, GT, SX, and ST	Arria V GZ
DDR3 SDRAM	1.5	533	667	800
	1.35	533	600	800
DDR2 SDRAM	1.8	400	400	400
LPDDR2 SDRAM	1.2	—	400	—
RLDRAM 3	1.2	—	—	667
RLDRAM II	1.8	—	400	533
	1.5	—	400	533
QDR II+ SRAM	1.8	—	400	500
	1.5	—	400	500
QDR II SRAM	1.8	—	400	333
	1.5	—	400	333
DDR II+ SRAM(12)	1.8	—	400	—
	1.5	—	400	—

Related Information

External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

HPS External Memory Performance

Table 19: HPS External Memory Interface Performance

The hard processor system (HPS) is available in Arria V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	533
	1.35	533
LPDDR2 SDRAM	1.2	333

(12) Not available as Altera® IP.

Figure 9: Device Chip Overview for Arria V GX and GT Devices

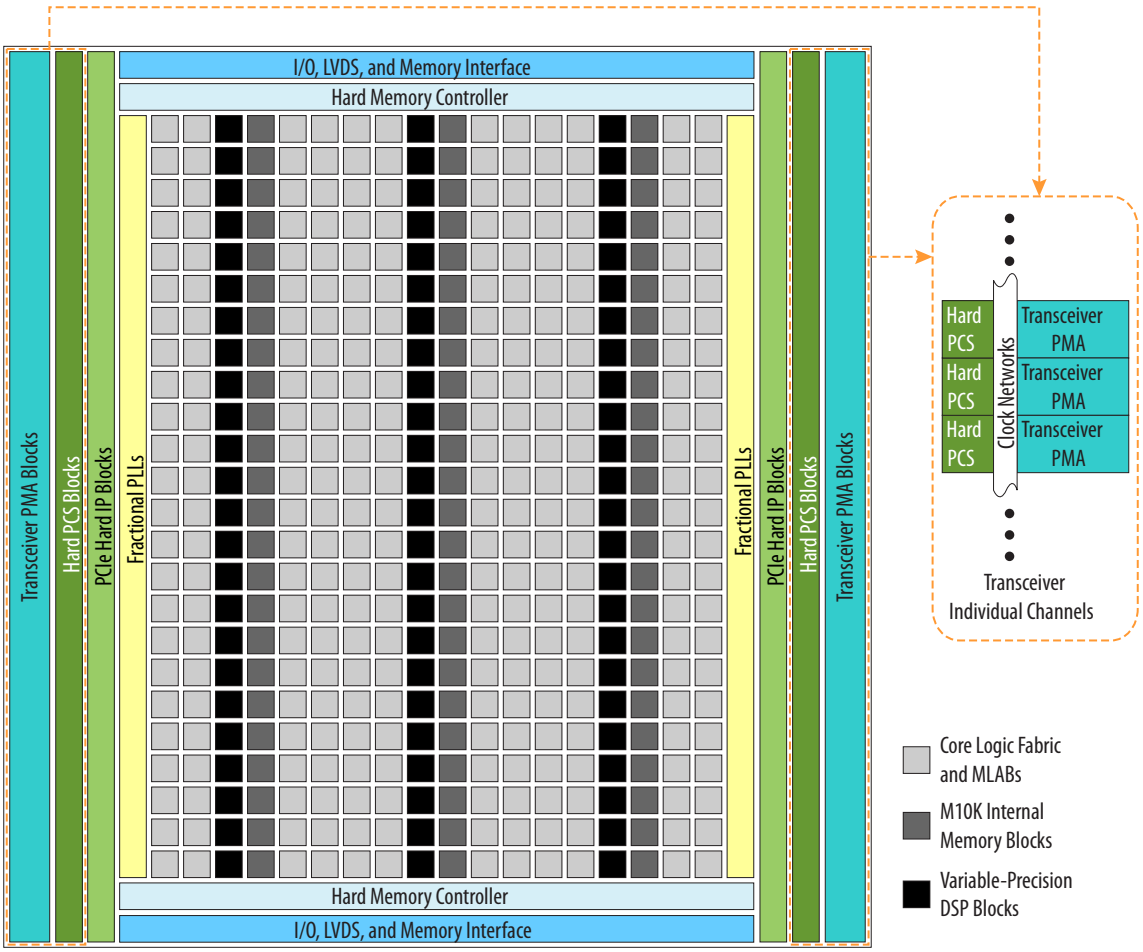
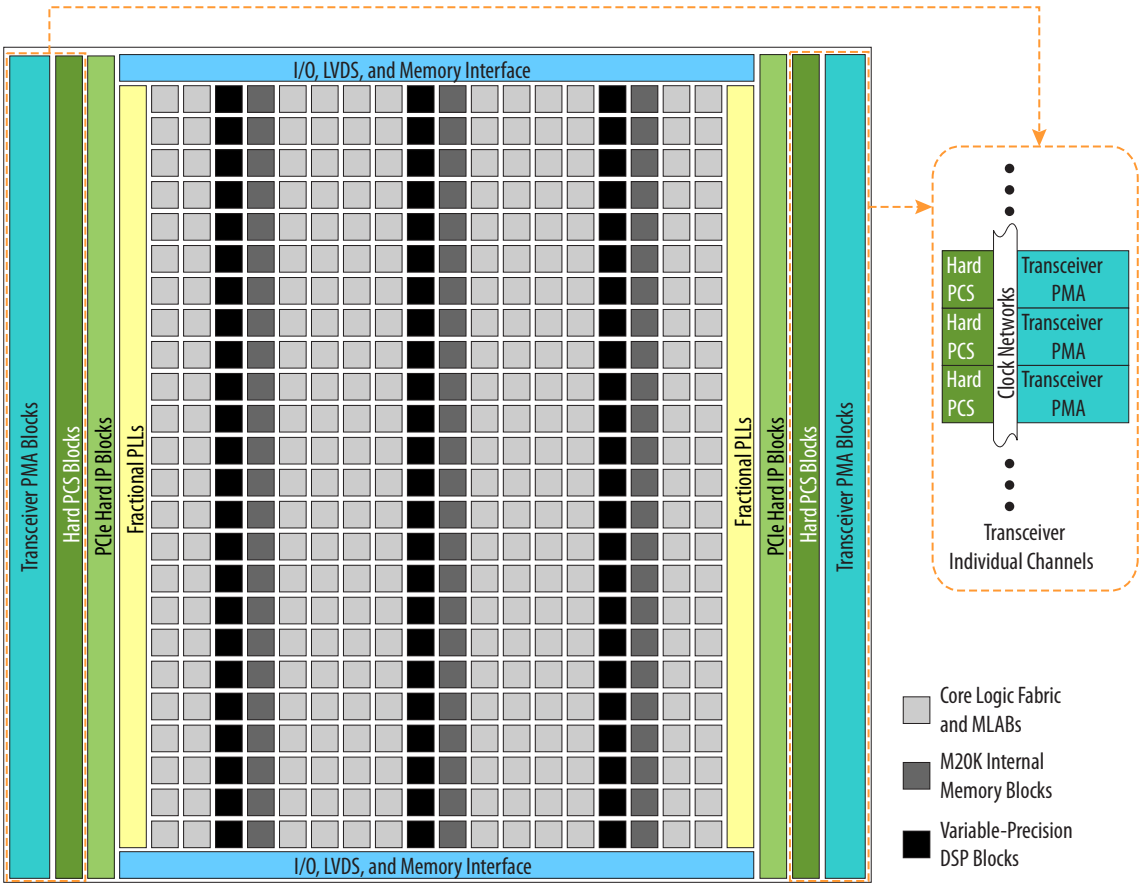


Figure 10: Device Chip Overview for Arria V GZ Devices



Features	Capability
PLL-based clock recovery	Superior jitter tolerance
Programmable serializer and deserializer (SERDES)	Flexible SERDES width
Equalization and pre-emphasis	• Arria V GX, GT, SX, and ST devices—Up to 14.37 dB of pre-emphasis and up to 4.7 dB of equalization • Arria V GZ devices—4-tap pre-emphasis and de-emphasis
Ring oscillator transmit PLLs	611 Mbps to 10.3125 Gbps
LC oscillator ATX transmit PLLs (Arria V GZ devices only)	600 Mbps to 12.5 Gbps
Input reference clock range	27 MHz to 710 MHz
Transceiver dynamic reconfiguration	Allows the reconfiguration of a single channel without affecting the operation of other channels

PCS Features

The Arria V core logic connects to the PCS through an 8, 10, 16, 20, 32, 40, 64, 66, or 67 bit interface, depending on the transceiver data rate and protocol. Arria V devices contain PCS hard IP to support PCIe Gen1, Gen2, and Gen3, GbE, Serial RapidIO (SRIO), GPON, and CPRI.

All other standard and proprietary protocols within the following speed ranges are also supported:

- 611 Mbps to 6.5536 Gbps—supported through the custom double-width mode (up to 6.5536 Gbps) and custom single-width mode (up to 3.75 Gbps) of the transceiver PCS hard IP.
- 6.5536 Gbps to 10.3125 Gbps—supported through dedicated 80 or 64 bit interface that bypass the PCS hard IP and connects the PMA directly to the core logic. In Arria V GZ, this is supported in the transceiver PCS hard IP.

Table 21: Transceiver PCS Features for Arria V GX, GT, ST, and SX Devices

PCS Support[13]	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
Custom single- and double-width modes	0.611 to ~6.5536	• Phase compensation FIFO • Byte serializer • 8B/10B encoder	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO
SRIO	1.25 to 6.25		
Serial ATA	1.5, 3.0, 6.0		

[13] Data rates above 6.5536 Gbps up to 10.3125 Gbps, such as 10GBASE-R, are supported through the soft PCS.

Table 22: Transceiver PCS Features for Arria V GZ Devices

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
Custom PHY	0.6 to 9.80	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering
GPON	1.25 and 2.5		
Custom 10G PHY	9.98 to 12.5	• TX FIFO • Gear box • Bit-slip	• RX FIFO • Gear box
PCIe Gen1 (x1, x2 x4, x8)	2.5 and 5.0	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • PIPE 2.0 interface to core logic	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer, • Byte ordering • PIPE 2.0 interface to core logic
PCIe Gen2 (x1, x2, x4, x8)			
PCIe Gen3 (x1, x2, x4, x8)	8.0	• Phase compensation FIFO • 128B/130B encoder • Scrambler • Gear box • Bit-slip	• Block synchronization • Rate match FIFO • 128B/130B decoder • Descrambler • Phase compensation FIFO
10GbE	10.3125	• TX FIFO • 64B/66B encoder • Scrambler • Gear box	• RX FIFO • 64B/66B decoder • Descrambler • Block synchronization • Gear box
Interlaken	3.125 to 12.5	• TX FIFO • Frame generator • CRC-32 generator • Scrambler • Disparity generator • Gear box	• RX FIFO • Frame generator • CRC-32 checker • Frame decoder • Descrambler • Disparity checker • Block synchronization • Gear box

Document Revision History

Date	Version	Changes
December 2015	2015.12.21	• Updated RoHS and optional suffix information in sample ordering code and available options diagrams for Arria V GX and GT devices. • Changed instances of *Quartus II* to *Quartus Prime*.
January 2015	2015.01.23	• Updated package dimension for Arria V GZ H780 package from 29 mm to 33 mm. • Updated dual-core ARM Cortex-A9 MPCore processor maximum frequency from 800 MHz to 1.05 GHz.
December 2013	2013.12.26	• 10-Gbps Ethernet (10GbE) PCS and Interlaken PCS are for Arria V GZ only. • Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables. • Added link to **Altera Product Selector** for each device variant. • Added leaded package options. • Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F896 package from 170 to 250. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1152 package from 350 to 385. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1517 package from 528 to 540. • Corrected LVDS Transmitter for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 devices from 121 to 120. • Added links to Altera's **External Memory Spec Estimator** tool to the topics listing the external memory interface performance. • Added x2 for PCIe Gen3, Gen 2, and Gen 1.
August 2013	2013.08.19	• Removed the note about the PCIe hard IP on the right side of the device in the F896 package of the Arria V GX variant. These devices do not have PCIe hard IP on the right side. • Added transceiver speed grade 6 to the available options of the Arria V SX variant. • Corrected the maximum LVDS transmitter channel counts for the Arria V GX A1 and A3 devices from 68 to 67. • Corrected the maximum FPGA GPIO count for Arria V ST D5 devices from 540 to 528.

Date	Version	Changes
July 2012	2.1	• Added –I3 speed grade to Figure 1 for Arria V GX devices. • Updated the 6-Gbps transceiver speed from 6.553 Gbps to 6.5536 Gbps in Figure 3 and Figure 1.
June 2012	2.0	• Restructured the document. • Added the "Embedded Memory Capacity" and "Embedded Memory Configurations" sections. • Added Table 1, Table 3, Table 12, Table 15, and Table 16. • Updated Table 2, Table 4, Table 5, Table 6, Table 7, Table 8, Table 9, Table 10, Table 11, Table 13, Table 14, and Table 19. • Updated Figure 1, Figure 2, Figure 3, Figure 4, and Figure 8. • Updated the "FPGA Configuration and Processor Booting" and "Hardware and Software Development" sections. • Text edits throughout the document.
February 2012	1.3	• Updated Table 1–7 and Table 1–8. • Updated Figure 1–9 and Figure 1–10. • Minor text edits.
December 2011	1.2	Minor text edits.
November 2011	1.1	• Updated Table 1–1, Table 1–2, Table 1–3, Table 1–4, Table 1–6, Table 1–7, Table 1–9, and Table 1–10. • Added "SoC FPGA with HPS" section. • Updated "Clock Networks and PLL Clock Sources" and "Ordering Information" sections. • Updated Figure 1–5. • Added Figure 1–6. • Minor text edits.
August 2011	1.0	Initial release.